

Defect Engineering in Oxide Heterostructures by Enhanced Oxygen Surface Exchange

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The synthesis of materials with well-controlled composition and structure improves our understanding of their intrinsic electrical transport properties. Recent developments in atomically controlled growth have been shown to be crucial in enabling the study of new physical phenomena in epitaxial oxide heterostructures. Nevertheless, these phenomena can be influenced by the presence of defects that act as extrinsic sources of both doping and impurity scattering. Control over the nature and density of such defects is therefore necessary to fully understand the intrinsic materials properties and exploit them in future device technologies. Here, it is shown that incorporation of a strontium copper oxide nano-layer strongly reduces the impurity scattering at conducting interfaces in oxide $\text{LaAlO}_3\text{-SrTiO}_3(001)$ heterostructures, opening the door to high carrier mobility materials. It is proposed that this remote cuprate layer facilitates enhanced suppression of oxygen defects by reducing the kinetic barrier for oxygen exchange in the hetero-interfacial film system. This design concept of controlled defect engineering can be of significant importance in applications in which enhanced oxygen surface exchange plays a crucial role.

1. Introduction

Advances in material growth have enabled progressive control of the crystalline quality and impurity density of scientifically and technologically important materials. Traditionally, single crystals have been used to study the intrinsic transport properties of complex oxide materials, in which electron–electron correlation effects, electron–lattice interactions, and orbital physics are important. Single crystal growth occurs near thermal equilibrium, allowing a minimal amount of impurities and defects, which is advantageous for transport and other experiments. For example, doped bulk SrTiO_3 crystals exhibit Shubnikov-deHaas (SdH) oscillations^[1] for sufficiently low dopant concentrations (Nb, La, oxygen vacancies). In recent years, such quantum oscillations have also been observed in oxide thin films, for example SrRuO_3 ^[2] and SrTiO_3 ,^[3] where, in particular, molecular beam epitaxy has been successful in reducing the

presence of extrinsic scatterers in the system. The next step of dimensional reduction to ultrathin films, with thicknesses down to the atomic scale, has generally led to the degradation of the transport properties.^[4] A perfect model system for the endeavour of combining ultrathin film thicknesses with high carrier mobilities has been found in the $\text{LaAlO}_3\text{-SrTiO}_3$ oxide heterostructure system.^[5,6]

The remarkable electronic transport properties that occur at the interface between the band insulators SrTiO_3 and LaAlO_3 ^[5–7] have been attributed to the avoidance of a so-called polar catastrophe, which would result from the polarity discontinuity across the nonpolar/polar interface between SrTiO_3 and LaAlO_3 . In the idealized case, a build-up of electric potential within the LaAlO_3 would trigger the transfer of electrons from the LaAlO_3 surface, through the LaAlO_3 layer, into the SrTiO_3 conduction band for a LaAlO_3 film thickness above a threshold value of 3–4 unit cells.^[8] Addition of an extra SrTiO_3 capping layer changes the situation dramatically, preventing structural and chemical reconstructions at the LaAlO_3 surface, and results

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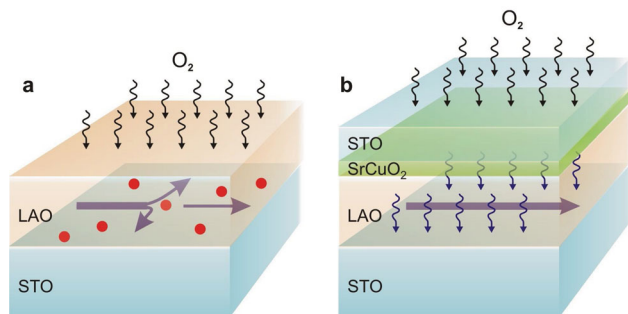


Figure 1. Schematic representation of enhanced oxygen incorporation in SrTiO_3 –(SrCuO_2)– LaAlO_3 – $\text{SrTiO}_3(001)$ heterostructures. a) The limited oxygen surface exchange causes the presence of oxygen vacancies at an LaAlO_3 – $\text{SrTiO}_3(001)$ interface leading to defect scattering. b) The introduction of a SrCuO_2 layer enhances the oxygen exchange and eliminates the oxygen vacancies resulting in reduced scattering of the carriers at the interface. Carrier transport at the interface is indicated by blue arrows, while the oxygen vacancies are represented by red points.

in metallic behavior below this threshold, even down to a single LaAlO_3 unit cell layer.^[9,10] However, to date, although the avoidance of the polar catastrophe is thought by many to lie at the heart of the remarkable physics displayed by these systems, the exact balance between doping via the electronic reconstruction versus from vacancy defects^[11–15] or cation intermixing^[16,17] is still a matter of ongoing debate.

The exact balance between the different possible sources of electrons residing at or near to the $\text{SrTiO}_3/\text{LaAlO}_3$ interface (Figure 1a), results in reported carrier mobilities of only several thousands $\text{cm}^2 \text{V}^{-1} \text{s}^{-1}$.^[18,19] For the development of systems based on interfaces with such quality suitable for devices, enhanced mobilities are required. In this context, one important challenge is to reduce the number of activated carriers and to further enhance the mobility, via reduction of (extrinsic) sources of carrier scattering. Oxygen vacancies—when present near the two-dimensional electron gas (2DEG) where the mobile states are hosted—act as point defects and strong charge carrier scatterers, in addition to cation defects as well as interface scattering. Therefore, a proven design strategy to minimize and sideline these almost ubiquitous defects would represent a significant leap forward.

In (ultra)thin-film heterointerface systems, the incorporation of oxygen during cool down of the film stack after growth is crucial to minimize the possible presence of oxygen vacancies. To ensure maximal surface oxygen exchange, three main processes have to be optimal: the reaction of oxygen at the surface of the as-grown film; the transfer from the surface into the crystal; and lastly the transport within the crystal.^[20] In the first step, molecular oxygen is transformed into oxide ions in the outermost layer of the film stack in a reaction involving both electron transfer and ion transfer. The subsequent chemical diffusion of oxide ions into the bulk involves both ionic and electronic species (i.e., oxygen vacancies and holes), so as to maintain global charge neutrality.^[21]

Previous studies of oxygen exchange kinetics in SrTiO_3 (and variations thereof) have shown that this process can be strongly accelerated by addition of a porous Ag or Pt film on top of the

SrTiO_3 .^[22] This is evidently not a particularly viable process step in the case of heteroepitaxial oxide film stacks such as those studied here. An alternative is to add an overlayer of a layered cuprate such as $\text{YBa}_2\text{Cu}_3\text{O}_{7-\delta}$, at whose surface the reaction steps all occur very fast,^[23] meaning that the cuprate essentially delivers pre-formed oxide ions to the layer below^[20] possibly as a consequence of the high energy of the O_{2p} -dominated states at the top of the valence band of the cuprate.^[24] Given the similarity in lattice constants of cuprate systems and the $\text{SrTiO}_3/\text{LaAlO}_3$ basis of the heterointerface system, it should be feasible to grow cuprate layers epitaxially on the LaAlO_3 , followed by a passivating capping layer of SrTiO_3 .

In this study, we report on the conversion of these ideas into a successful strategy to minimize the deleterious effects of scattering related to oxygen defects in the LaAlO_3 – SrTiO_3 heterointerface. By introducing a remote layer containing strontium copper oxide, as schematically depicted in Figure 1b, the thermally activated carriers found in both the free and SrTiO_3 -capped heterointerface systems are suppressed, due to effective, cuprate-mediated avoidance of defects at the LaAlO_3 – SrTiO_3 interface. The results are significantly suppressed scattering and greatly enhanced carrier mobilities of the 2DEG states.

2. Results and Discussion

To compare the transport properties of SrTiO_3 – SrCuO_2 – LaAlO_3 – $\text{SrTiO}_3(001)$ heterostructures with the generally used (SrTiO_3)– LaAlO_3 – $\text{SrTiO}_3(001)$ interface structures (with or without SrTiO_3 capping layers), SrTiO_3 – SrCuO_2 – LaAlO_3 – $\text{SrTiO}_3(001)$ heterostructures were fabricated by pulsed laser deposition with reflection high-energy electron diffraction (RHEED) control of the growth process (see the methods section for the deposition settings). Figure 2a shows the RHEED analysis during growth of the SrTiO_3 – SrCuO_2 – LaAlO_3 – $\text{SrTiO}_3(001)$ heterostructures using pulsed laser deposition. The top panels display the RHEED intensity oscillations during growth of each individual layer indicating successful control on the unit cell (u.c.) scale due to the layer-by-layer growth mode. Results are given for the subsequent growth of a 10 u.c. LaAlO_3 layer, a 1, 2, or 3 u.c. SrCuO_2 layer, and a 2 u.c. SrTiO_3 toplayer. In Figure 2b, the corresponding RHEED patterns are shown for the TiO_2 -terminated $\text{SrTiO}_3(100)$ substrate, LaAlO_3 layer, SrCuO_2 layer, and SrTiO_3 toplayer (from left to right), showing conservation of surface structure and low surface roughness. After growth, the heterostructures were slowly cooled to room temperature in 6×10^{-2} mbar of oxygen at a rate of $10^\circ\text{C min}^{-1}$. X-ray photoelectron spectroscopy indicates that Cu in the SrCuO_2 layer for all heterostructures is in a valence state of 2+ (although small contributions of $3d^9L$ configurations cannot be ruled out). In case of SrTiO_3 – SrCuO_2 – LaAlO_3 – $\text{SrTiO}_3(001)$ heterostructures grown on SrO -terminated $\text{SrTiO}_3(100)$ substrates, the samples were insulating in standard transport measurements. The low level of surface roughness was confirmed by atomic force microscopy (AFM) analysis of the surface of a 2/1/10 SrTiO_3 – SrCuO_2 – LaAlO_3 – $\text{SrTiO}_3(001)$ heterostructure. Figure 2c shows the topographic image and the roughness analysis, indicating smooth terraces separated by clear, single unit cell height steps similar to the surface of the initial TiO_2 -terminated $\text{SrTiO}_3(100)$ substrate.

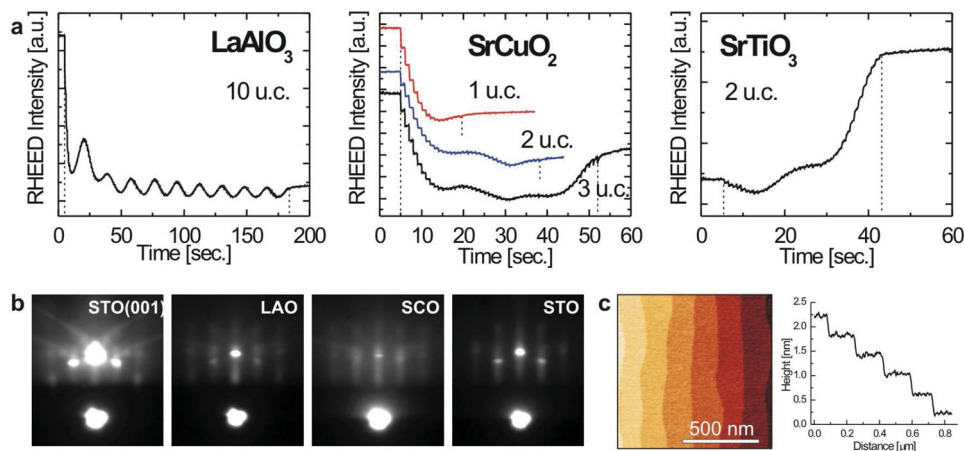


Figure 2. Thin film growth of SrTiO₃–SrCuO₂–LaAlO₃–SrTiO₃(001) heterostructures by pulsed laser deposition. a) RHEED intensity monitoring during growth of subsequently a 10 u.c. LaAlO₃ layer, a 1, 2 or 3 u.c. SrCuO₂ layer and a 2 u.c. SrTiO₃ toplayer. Clear intensity oscillations indicate layer-by-layer growth of single unit cells. Dashed lines indicate start/stop of laser pulses. b) RHEED patterns after growth of each consecutive layer. c) Surface topography and roughness analysis of a 2/1/10 SrTiO₃–SrCuO₂–LaAlO₃–SrTiO₃(001) heterostructure by AFM of a 1 μm × 1 μm area.

Thus, Figure 2 shows we are able to grow SrTiO₃/LaAlO₃ interface systems incorporating a cuprate oxide ion "supplier" layer, which, as we will go on to show later, removes oxygen vacancies from the region of the 2DEG. In Figure 3, we turn to the transport characterization of these systems. All conducting heterostructures exhibit metallic transport behavior down to 2 K. In Figure 3a, the temperature dependence of the carrier density is shown, which has been extracted from the Hall coefficient. The uppermost trace (□) shows the behavior for a 10 unit cell LaAlO₃ layer, which displays a large number of activated carriers ($\approx 1.8 \times 10^{14} \text{ cm}^{-2}$, at room temperature), which freeze out at lower temperatures, resulting in 3×10^{13} carriers per cm² at 2 K. This carrier freeze out has been observed in previous LaAlO₃–SrTiO₃(001) interface studies at an energy scale of 6.0 meV,^[9] which is comparable to observations in SrTiO₃ at

low La doping.^[25] A typical donor-like defect band located a few meV below the conduction band of SrTiO₃ has been associated with the loss of mobile carriers at low temperatures,^[26] schematically indicated in red in the top inset of Figure 3a.

Addition of a 2 unit cell SrTiO₃ cap on a 10 unit cell LaAlO₃ film (○), reduces the room temperature carrier density to just above $1 \times 10^{14} \text{ cm}^{-2}$, and further carrier freeze-out on lowering the temperature brings this system to the same low temperature carrier density as the uncapped system. The solid triangles (stars) show carrier data for one (three) unit cells of SrCuO₂ on a 10 unit cell LaAlO₃ film, with a 2 unit cell SrTiO₃ cap. It is evident that the heterointerfaces containing the remote cuprate layer behave quite differently: the activated carriers are no longer present, and both samples with a single and three unit cell thick SrCuO₂ layer the interface systems a fully

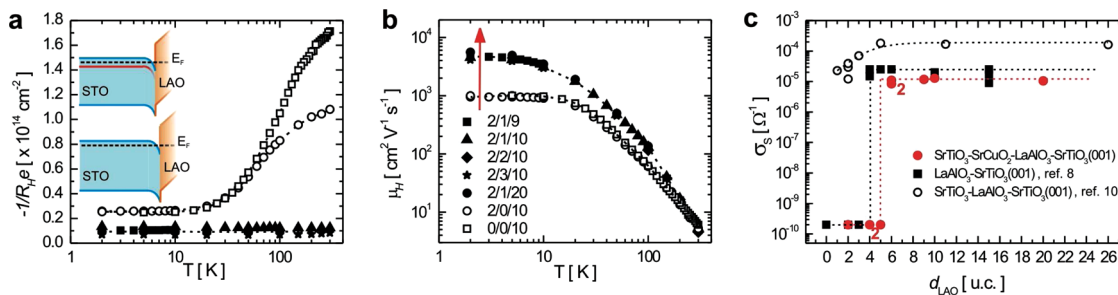


Figure 3. Transport properties of SrTiO₃–(SrCuO₂)–LaAlO₃–SrTiO₃(001) heterostructures. a) With or without a SrCuO₂ layer. Temperature dependence of $-1/R_{\text{H}}e$ (where R_{H} is the Hall coefficient and e is the elementary charge), indicating the carrier density, for heterostructures with (closed symbols) and without (open symbols) a SrCuO₂ layer. The corresponding bandstructures are schematically represented in the insets. When the additional SrCuO₂ layer is introduced, the commonly observed defect donor band (shown in red in the top inset) is eliminated (bottom inset). b) Corresponding temperature dependence of Hall mobility μ_{H} . Various heterostructure configurations are given, for example 2/1/10 SrTiO₃–SrCuO₂–LaAlO₃–SrTiO₃(001) represents a 2 u.c. SrTiO₃ toplayer with a 1 u.c. SrCuO₂ layer and a 10 u.c. LaAlO₃ layer on a SrTiO₃ substrate; in the heterostructure indicated with 2/0/10 SrTiO₃–SrCuO₂–LaAlO₃–SrTiO₃(001), the SrCuO₂ layer is absent. c) Sheet conductance dependence on LaAlO₃ layer thickness at 300 K. Heterostructures with a SrCuO₂ layer exhibit a sharp insulator–metal transition at a LaAlO₃ layer thickness of 6 unit cells. Data for LaAlO₃–SrTiO₃(001) single interfaces from Thiel et al.^[8] and for coupled interfaces in SrTiO₃–LaAlO₃–SrTiO₃(001) heterostructures from Pentcheva et al.^[10] are also shown for comparison.

temperature independent carrier concentration of $\approx 1 \times 10^{13} \text{ cm}^{-2}$ is observed. This means that the cuprate layer has successfully eliminated the defect-related, donor impurity band, and the related thermally activated carriers.

The direct consequence of this successful defect engineering is an improvement in carrier mobility, as shown in Figure 3b. The solid symbols show that (2 unit cell) SrTiO_3 -capped film systems comprising 9 or 10 LaAlO_3 unit cells and 1, 2, or 3 SrCuO_2 unit cells all show identical behavior, with a mobility significantly above that of the cuprate-free films for all temperatures below 150 K. At low temperatures, the SrCuO_2 -containing systems reach carrier mobilities up to $5500 \text{ cm}^2 \text{ V}^{-1} \text{ s}^{-1}$, a factor five greater than the control films without the cuprate layer. A minimum interfacial carrier density of $\approx 7 \times 10^{12} \text{ cm}^{-2}$ was measured for our heterostructures, which can be re-calculated as a minimum volumetric carrier density of $\approx 7 \times 10^{18} \text{ cm}^{-3}$ by taking an upper limit of 10 nm for the thickness of the conducting interfacial region.^[27] Therefore, the observed variations in carrier densities are all in a range well above $\approx 3 \times 10^{17} \text{ cm}^{-3}$, where a maximum carrier mobility for reduced bulk SrTiO_3 is reported^[12] and, thus our observation of an increase in carrier mobility on decreasing the carrier density is in good agreement with previously reported studies. This underpins the hypothesis that the donor states in the cuprate-less systems are a source of significant scattering for the 2DEG states, and that these are effectively eliminated by the introduction of the cuprate inter layer. Indeed, similar samples have been investigated using high-field magnetotransport measurements,^[28] and clear 2DEG sub-band structure has been resolved in these data, attesting to the high quality and low scattering the cuprate layer brings about.

The final panel of Figure 3 compares the critical thicknesses of the LaAlO_3 layer required to support metallic conductivity at low temperatures. In the “first generation”, uncapped films of LaAlO_3 on SrTiO_3 , the critical thickness is the well-known figure of four unit cells.^[8] On capping the LaAlO_3 with SrTiO_3 (“second generation” systems), the critical thickness sinks to a single unit cell.^[9,10] For the “third generation” of films of

LaAlO_3 on SrTiO_3 with a cuprate interlayer, Figure 3c shows the critical thickness to be 6 unit cells, indicating a great sensitivity of the conducting channel at and near the $\text{SrTiO}_3/\text{LaAlO}_3$ interface to the electrostatic and chemical termination of the film stack located on top of the LaAlO_3 layer. The electrical current in transport measurements does not additionally travel a parallel path through the SrCuO_2 layer, as demonstrated by the insulating behavior in the case of $\text{SrTiO}_3\text{-SrCuO}_2\text{-LaAlO}_3\text{-SrTiO}_3(001)$ heterostructures grown on SrO -terminated $\text{SrTiO}_3(100)$ substrates (not shown).

Thus far, we have explained the design strategy behind the cuprate layer, and the transport data have shown this approach to be successful in boosting the mobility of the carriers in the 2DEG. We now return to the film itself and present data from both transmission electron microscopy and X-ray absorption spectroscopy that hold a surprise in store as regards the structure of the SrCuO_2 inter layer, which proved so effective in reducing the scattering of the 2DEG carriers in the $\text{SrTiO}_3/\text{LaAlO}_3$ heterointerface. We have used atomic resolution scanning transmission electron microscopy combined with electron energy loss spectroscopy (STEM-EELS) to investigate the local composition/structure and crystal lattice parameters of the $\text{SrTiO}_3\text{-SrCuO}_2\text{-LaAlO}_3\text{-SrTiO}_3(001)$ heterostructures. A high-angle annular dark-field scanning transmission electron microscopy (HAADF-STEM) image of the heterostructure is shown in Figure 4a, together with the schematic representation of the individual layers. Clear epitaxial ordering can be observed throughout the complete heterostructure, which is free of structural defects. The observed thicknesses of the individual layers (10 u.c. LaAlO_3 + 1 u.c. SrCuO_2 + 2 u.c. SrTiO_3) measured using STEM match perfectly with the unit-cell controlled growth during PLD deposition monitored using RHEED. A quantitative elemental map of the conducting $\text{LaAlO}_3\text{-SrTiO}_3(001)$ interface is shown in Figure 4b, and displays data from the La $M_{4,5}$, Ti $L_{2,3}$, and O K edges, which are enhanced by application of a principal components analysis (PCA) to improve the signal to noise ratio in the EELS spectra.

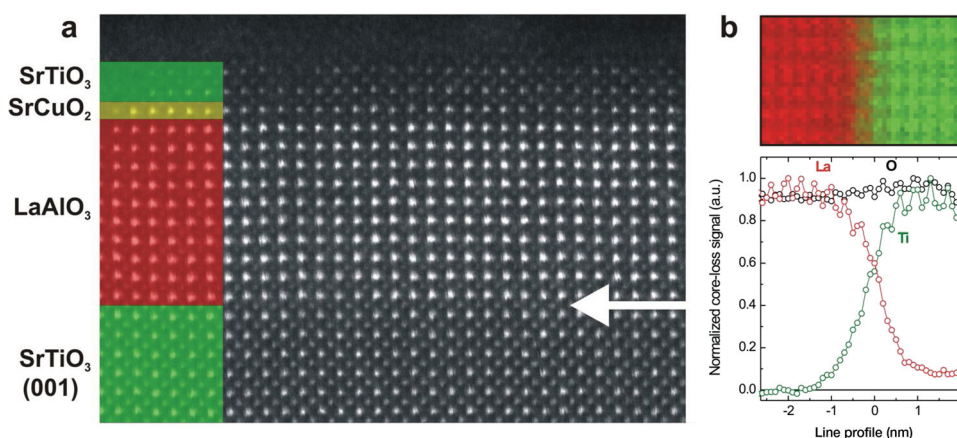


Figure 4. Quantitative scanning transmission electron microscopy analysis of the atomic stacking sequences in $\text{SrTiO}_3\text{-SrCuO}_2\text{-LaAlO}_3\text{-SrTiO}_3(001)$ heterostructures. a) HAADF-STEM image of the heterostructure along the [001] zone axis, together with the schematic representation of the individual layers. b) EELS analysis of the conducting $\text{LaAlO}_3\text{-SrTiO}_3(001)$ interface within the heterostructure showing normalized core-loss signals for La $M_{4,5}$ (red), Ti $L_{2,3}$ (green), and O K (black) edges.

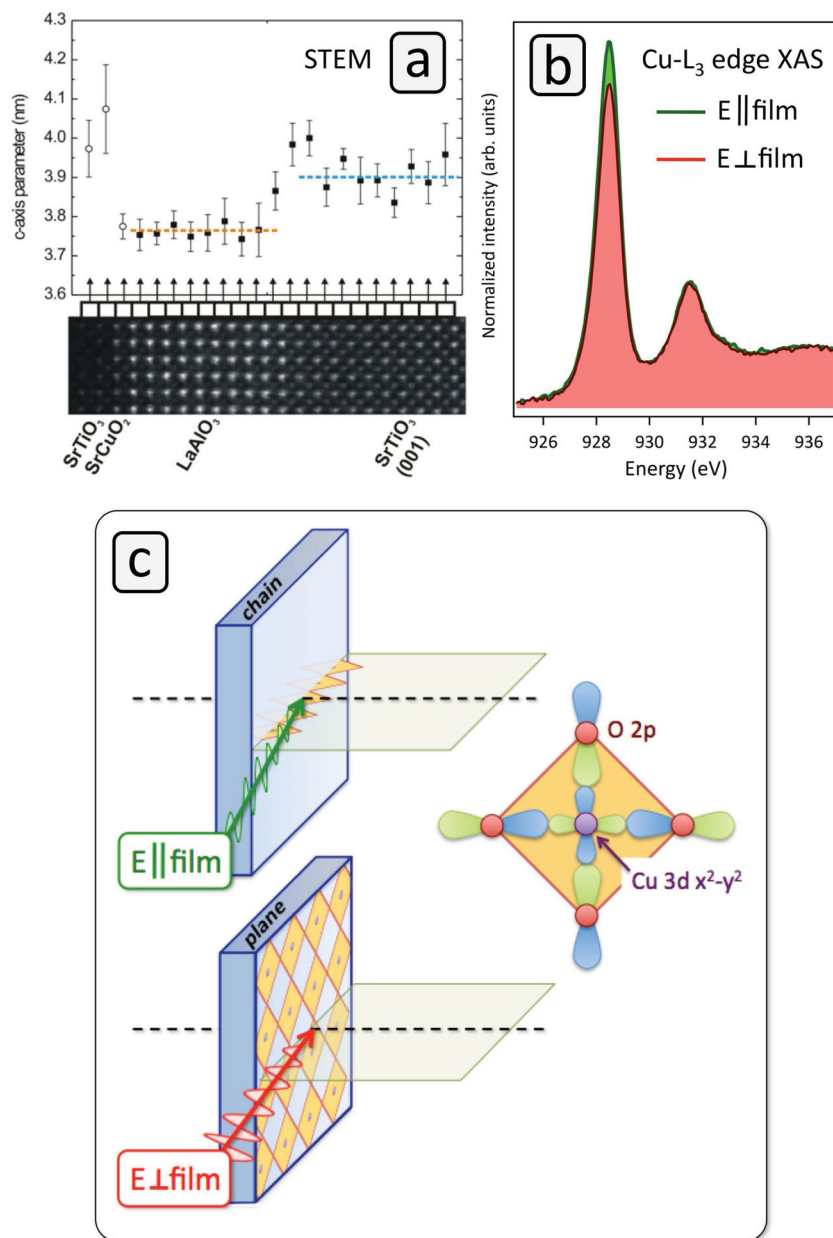


Figure 5. Structural ordering of the incorporated SrCuO₂ layer. a) Quantification by STEM of the *c*-axis parameter for the SrTiO₃-SrCuO₂-LaAlO₃-SrTiO₃(001) heterostructure using the single crystalline SrTiO₃(001) substrate as a calibration standard. The distances between the atomic planes in LaAlO₃ and SrTiO₃(001) are indicated as closed squares, while open circles are used for the SrCuO₂ and SrTiO₃ toplayer. Furthermore, 95% confidence intervals are shown. b) Linear dichroism in X-ray absorption at the Cu-L₃ absorption edge for a 2/1/4 SrTiO₃-SrCuO₂-LaAlO₃-SrTiO₃(001) heterostructure. The white line at 928.5 eV is only 9% more intense for the polarization vector in the plane of the film, compared to perpendicular. c) Simplified sketch of possible SrCuO₂ structures. Upper: chain-like, such that the E || film case places the E-vector out of the CuO₄-plaquettes. Lower: plane-like, such that only the E perpendicular to the film case places the E-vector out of the CuO₄-plaquettes. Right: cartoon of the low lying electronic states in a cuprate CuO₄ plaquette, showing the Cu3d_{x²-y²} and O2p_{x,y} orbitals. These states are the first electron addition states for a divalent cuprate and are polarized in the plaquette.

The elemental map and the corresponding La, Ti and O line profiles across the SrTiO₃-LaAlO₃ interface show minimal La diffusion into the SrTiO₃ substrate.^[29]

STEM images, there is no detectable change in the average of the lattice parameter parallel to the interface, consistent with a high-quality, pseudomorphically constrained thin film.

The HAADF-STEM images are of sufficient quality to enable the analysis of possible local structural variations, via direct determination of lattice parameter changes for each unit cell of the heterointerface film stack. To do this, we use atomic position quantification from the aberration corrected HAADF-STEM images, building upon the approach recently introduced by Van Aert et al.^[30,31] for TEM images. This allows position measurements of all atomic columns with a precision of a few picometers without being restricted by the resolution of the microscope. **Figure 5a** shows a strip out of a HAADF-STEM image of the SrTiO₃-SrCuO₂-LaAlO₃-SrTiO₃(001) heterostructure. The corresponding graph plots the values of the (pseudo)cubic lattice parameter *c* (normal to the interface), calculated from the atomic column positions in the HAADF-STEM image together with their 95% confidence intervals. Using the lattice parameter of the single crystal SrTiO₃(001) substrate (3.905 Å)^[32] as a reference, we determine the *c*-axis lattice parameter of the grown LaAlO₃ layer (≈3.75 Å) to be in good agreement with previous results from X-ray diffraction of such thin films.^[7] Now turning to the cuprate and SrTiO₃ capping layers, the data show that for the former the *c*-axis lattice parameter is essentially the same as that of the LaAlO₃ at 3.75 Å. The top SrTiO₃ capping layer exhibits a *c*-axis lattice parameter of ≈4 Å. Given stoichiometric transfer of the SrCuO₂ target to the cuprate film, two possible Cu-O networks are possible in the sandwich between the LaAlO₃ and SrTiO₃ cap. Firstly, the “infinite layer” structure, comprising of a single CuO₂ plane (see lower part of Figure 5c) and out-of-plane Sr ions, which in bulk form has a *c*-axis lattice parameter of 3.4 Å.^[33] The second possibility would be an arrangement in which the CuO₄-plaquettes lie in the plane of the film normal, and are arranged as a corner sharing chain, as sketched in the upper part of Figure 5c. This would mean—compared to the infinite layer structure—that oxygen atoms are moving to out-of-plane positions, giving rise to an effective Cu-O and Sr-O layering along the *c*-direction. As a bulk crystal, this Cu-O network can be found in Sr₂CuO₃, and, translated to the axis system of the film stack, this kind of corner sharing chain system would possess a *c*-axis lattice parameter of ≈3.9 Å.^[34] Based on these observations, there is strong support for the plaquette arrangement over the infinite layer. Furthermore, in the field of view of the

Seeing as the ultrathin SrCuO₂ layer is too sensitive to the electron beam to be investigated using EELS in the TEM, we have used polarization-dependent X-ray absorption at the Cu-L₃ edge to investigate both 2/1/4 and 2/1/6 SrTiO₃-SrCuO₂-LaAlO₃-SrTiO₃(001) heterostructures, with the data for a 2/1/4 sample being shown in Figure 5b. The Cu-L₃ edge probes Cu2p → Cu3d excitations and, for a divalent system composed of CuO₄-plaquettes the only available final state (2p⁵3d¹⁰) involves the Cu3d_{x₂-y₂} orbital, which lies in the plane of the plaquette (see Figure 5c). Therefore, in the context of the issue at hand, the dichroism in the X-ray absorption between an experiment placing the E-vector in and perpendicular to the film plane will provide information on the structure of the cuprate layer. For the infinite layer structure, E_{||} film would yield a strong so-called white line (2p⁶3d⁹ → 2p⁵3d¹⁰), and for the E-vector pointing out of the film plane, almost no intensity would be expected.^[35] For the Cu-O chain comprised of edge-sharing plaquettes, bulk Sr₂CuO₃ is a good reference material, and again here the Cu-L₃ white line is strong for E in the plane of the plaquettes and ten times weaker for E perpendicular to the plaquettes.^[36] For the data shown in Figure 5b, the X-rays are incident at a grazing angle to the film-stack, with either E_{||} film (linear vertical polarization as shown in Figure 5c) or E perpendicular to the film (linear horizontal polarization in Figure 5c). As Figure 5b makes very clear, the Cu-L₃ white line is only a little stronger for E_{||} film than for E_⊥ film. This rules out a pure infinite layer structure for the SrCuO₂, in agreement with the STEM data of Figure 5a. Over the macroscopic area of 0.1 mm × 2.6 mm probed by the grazing incidence XAS experiment—if we assume equal proportions of Cu-O chains running along the two in-plane axes of the film—the data of Figure 5b would be consistent with more than 60% of the CuO₄-plaquettes in a “standing”, or chain-like configuration, and only 40% arranged as in the infinite layer structure.

Recent DFT-based calculations^[37] have studied the question of the lowest energy structure for such ultrathin cuprate layers in film stacks such as those under investigation here, coming to the conclusion that the SrCuO₂ should be present in the form of edge-sharing chain structures, with the thin film normal lying in the plane of the CuO₄-plaquettes. This expectation matches well with both the *c*-axis distances observed in the STEM data (Figure 5a) as well as with the fact that only weak linear dichroism is observed in the polarized X-ray absorption data (Figure 5b). A preliminary conclusion would be to correlate the chain-like structure of the cuprate layer to the enhanced oxygen uptake, which needs more detailed analysis.

To determine the mechanism of the remote strontium-copper-oxide layer to eliminate defects, additional experiments have been performed. An intermediate cool down step to room temperature in between the depositions of LaAlO₃ and SrCuO₂ was applied. Due to this additional step, thermally activated carriers were observed, similar to those interface structures without a SrCuO₂ layer. This observation also excludes intermixing as the possible cause for creation of defects. In order to further investigate the phenomenology of the strontium copper oxide layer in the elimination of defects, we have performed two additional sets of experiments. Firstly, a series of heterostructures have been fabricated under different oxygen partial pressures during the growth of the LaAlO₃ layer. Figure 6a displays carrier concentration data showing that over a wide oxygen pressure regime, from 10⁻³ to 10⁻⁶ mbar, the incorporation of a SrCuO₂ layer results in the removal of the thermally activated carriers and their associated donor defect levels, leaving a constant low carrier density over the entire temperature range (excluding the effects of oxygen defects in the bulk of the substrate, as reported previously for lowest oxygen partial pressures).^[5,12] Interestingly, carrier mobilities in excess of 50 000 cm² V⁻¹ s⁻¹ are observed for the 3rd generation 2DEGs grown in the lowest oxygen partial pressures (Figure 6b).

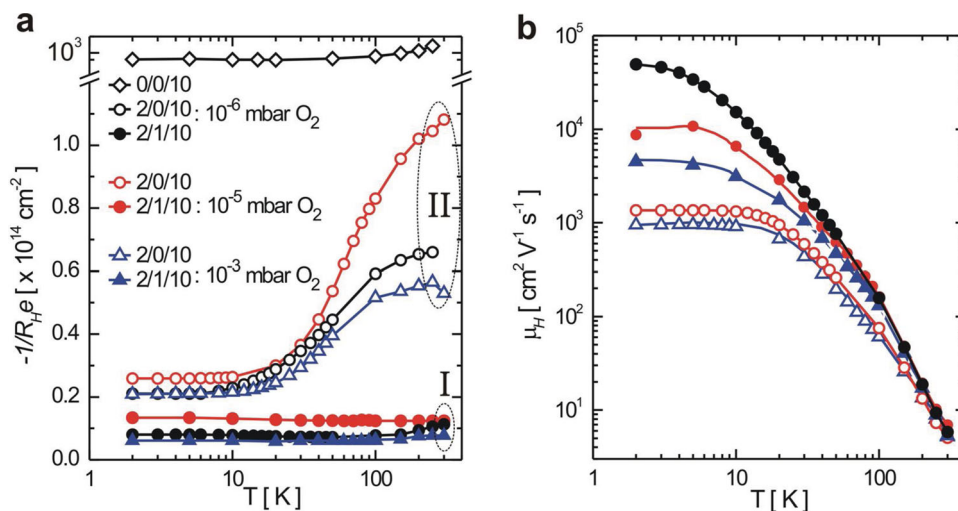


Figure 6. Mobility enhancement by defect engineering over a wide oxygen pressure regime. Temperature dependence of a) $-1/R_{H,e}$, indicating the carrier density, and b) Hall mobility μ_H for SrTiO₃-(SrCuO₂)-LaAlO₃-SrTiO₃(001) heterostructures with (group I: closed symbols) and without (group II: open symbols) a SrCuO₂ layer for various oxygen growth pressures. The corresponding Hall resistance versus magnetic field exhibits linear dependence for the complete temperature range (2–300 K), indicating the presence of a single type of carrier. The carrier mobilities of the 2/0/10 and 0/0/10 (10⁻⁶ mbar O₂) samples were excluded as nonlinear dependence is observed in the former and bulk conductivity in the latter.

These results demonstrate a marked dependence of the observed carrier mobility on the oxygen pressure during growth of the heterostructures with a SrCuO₂ layer. The differences between those samples with and without the cuprate interlayer allow us to make a separation of the effects on the final carrier mobility observed for the complete heterostructure system: the initial oxidation level of the heterostructure/substrate, the disorder induced by bulk diffusion within the single-crystalline substrate and possibly by the growth mode of the deposited material on the substrate surface. In the following, each of these factors is described in detail.

The oxygen pressure during deposition will determine the initial oxidation level of the LaAlO₃ thin film and interface during growth. It is known that in oxide materials oxygen vacancies can easily be formed when a low oxygen pressure is chosen in combination with high temperatures. Therefore, immediately after the growth of the LaAlO₃, some amount of oxygen vacancies can be present, and that this amount can be considerable, depending on the actual oxygen pressure used during growth. These vacancies could in part be eliminated during cool-down to room temperature. However, transport measurements for samples without the cuprate interlayer generally show the presence of activated carriers (e.g., see Figure 6), indicating that oxygen vacancies still exist for all interfaces grown in oxygen pressures in the range of 10⁻⁶–10⁻³ mbar. These samples have not been fully oxidized due to a limitation in the oxygen surface exchange. The remaining oxygen vacancies, which are charged impurities, act as scattering centers, limiting the mobility of the mobile charge carriers.

The bulk diffusion within the substrate crystal is also determined by the oxygen pressure used. It is known that Sr-diffusion within a SrTiO₃ substrate crystal is minimized at low oxygen pressures.^[38] Therefore, for oxide growth at low oxygen pressures such as 10⁻⁶ mbar a highly ordered TiO₂-terminated surface of the SrTiO₃ crystal can be maintained, resulting in a highly ordered LaAlO₃–SrTiO₃ interface. In contrast, for higher oxygen pressures of 10⁻³ mbar some Sr-diffusion to the SrTiO₃ surface could lead to a mixed-termination of TiO₂ and SrO, resulting in more disorder at the LaAlO₃–SrTiO₃ interface. The disorder will influence the scattering of the mobile charge carriers and, therefore, lower the carrier mobility for high oxygen pressures of 10⁻³ mbar. Additionally, the growth mode of LaAlO₃ on a SrTiO₃ substrate exhibits a transition from two-dimensional, layer-by-layer growth at low oxygen pressures to island growth at high oxygen pressures.^[7] The actual growth mode will influence the amount of disorder, and therefore the crystallinity, of the final LaAlO₃ thin film and, thus, the interfacial region. Local defects in the crystal structure will have a strong influence on the scattering of mobile charge carriers being transported in the 2D-layer at and near to the interface.

In the work presented here, we use a cuprate interlayer to dramatically enhance the oxygen surface exchange, thereby improving the oxidation of the whole system during cool-down and consequently reducing the amount of oxygen vacancies in our samples. That this factor is operative is clear in the elimination of activated carriers (see Figure 3), which leads to a significant decrease in the number of transport-active charge carriers observed at low temperature from values between 2.0–2.7 × 10¹³ cm⁻² to 0.7–1.4 × 10¹³ cm⁻² when this cuprate

layer is introduced. This effect is clearly present for all cuprate-containing samples grown in oxygen pressures in the range of 10⁻⁶–10⁻³ mbar (see Figure 6a).

At the same time, the addition of the cuprate layer leads to an increase in the carrier mobility, confirming the reduction of scattering by oxygen vacancies. The actual carrier mobility of the whole system depends on the remaining scattering of the mobile charge carriers from disorder at the interface caused by the growth mode and bulk diffusion at different oxygen pressures. The removal of the masking effect on the mobility due to oxygen-vacancy induced scattering achieved by adding the cuprate layer now enables us to zoom in on the next sources of scattering, which are clearly dependent on the oxygen pressure during growth of the LaAlO₃–SrTiO₃ interface. Growth in the highest oxygen pressure of 10⁻³ mbar results in a degree of disorder at the interface and a maximum carrier mobility of about 5500 cm² V⁻¹ s⁻¹. The intermediate oxygen pressure of 10⁻⁵ mbar gives rise to less disorder and a carrier mobility up to about 9000 cm² V⁻¹ s⁻¹. The lowest oxygen pressure of 10⁻⁶ mbar gives a region at/near the interface with the lowest disorder, which in turn leads to a very high low-temperature carrier mobility of about 50 000 cm² V⁻¹ s⁻¹. Thus, this research takes an important step in showing that the cuprate layer is crucial in the enhancement of the surface oxygen exchange so as to eliminate oxygen vacancies. The final carrier mobilities are then limited by remnant disorder, which can be minimized by growing at low oxygen pressure, such that low bulk diffusion and an ideal layer-by-layer growth give a highly ordered interface with low scattering and, therefore, a high carrier mobility.

A second set of additional experiments involved studying the influence of introducing various different cuprate layers besides SrCuO₂ such as CuO, YBa₂Cu₃O_{7-δ} and La_{1.85}Sr_{0.15}CuO₄ (data not shown). All of these cuprate layers showed the same strong reduction of impurity scattering signaled by the absence of the carrier freeze-out at low temperatures. Introduction of LaTiO₃ or LaNiO₃ layers instead of the cuprate layer did not have the same effect, demonstrating the particular efficacy of cuprate layers in enhancing the oxygen incorporation, thereby strongly reducing carrier scattering from oxygen vacancies at the interface.

Finally, it is also important to note that the SrTiO₃–SrCuO₂–LaAlO₃–SrTiO₃(001) heterostructures showed metallic behavior down to 60 mK without any signature of the superconductivity which has been observed previously in delta-doped SrTiO₃^[39] and at the LaAlO₃–SrTiO₃ interface.^[27] Seeing as the 2DEG we see in action here (the quantum oscillations of which are studied in detail elsewhere)^[28] is outside of the superconducting regime in the samples discussed here, this makes it clear that a high mobility quasi-2D electron gas and superconductivity can be observed independently in SrTiO₃, unlike has been concluded in an earlier report.^[39]

3. Conclusion

The introduction of a remote SrCuO₂ layer in the SrTiO₃-capped LaAlO₃–SrTiO₃ interface system strongly enhanced the electron mobility by eliminating the negative influence of defect states. This suppression of oxygen defects in oxide hetero-interfacial

film systems enables the fundamental study of previously inaccessible quantum phenomena in complex oxide 2DEGs. Furthermore, this design concept of controlled defect engineering can be of significant importance in applications in which enhanced oxygen surface exchange plays a crucial role.

4. Experimental Section

Atomically smooth TiO₂-terminated SrTiO₃(100) substrates were prepared by a combined HF-etching/anneal treatment. All substrates had vicinal angles of $\approx 0.1^\circ$. Single-crystal LaAlO₃ and SrTiO₃ targets as well as a stoichiometric SrCuO₂ target were ablated at a laser fluence of 1.3 J cm⁻² and a repetition rate of 1 Hz. During growth, the substrate was held at 850 °C in an oxygen environment at 2×10^{-3} mbar for LaAlO₃ (except when mentioned otherwise, while for SrCuO₂ and SrTiO₃ the conditions were adjusted to 650 °C and 6×10^{-2} mbar. The sheet carrier density and mobility were determined by a Hall measurement using a Van der Pauw configuration.

Atomic resolution STEM-EELS and HAADF-STEM measurements were performed using the Qu-Ant-EM microscope at the University of Antwerp consisting of a probe-corrected TITAN G2 80-300 (FEI) instrument equipped with a GIF Quantum spectrometer for electron energy loss spectroscopy (EELS). The effective probe-size during acquisition is approximately equal to 1.5 Å. Low loss and core-loss spectra are recorded quasi-simultaneously by using the spectrometer in dual EELS mode. The collection and convergence angle are $\alpha = 21$ mrad and $\beta = 25$ mrad, respectively. The energy resolution in STEM-EELS was approximately equal to 1.2 eV.

X-ray absorption measurements were carried out at the Cu-L_{2,3} edges using linearly polarized synchrotron radiation from the UE56/2-PGM-2 undulator beamline at the BESSY-II electron storage ring at the Helmholtz-Zentrum Berlin. The absorption cross-section was monitored using the drain current, and normalized in the pre-edge region. The films studied were transferred from the UHV PLD chamber in Twente to the XAS chamber at the light source in Berlin using a UHV sample transfer chamber, in which the pressure was maintained under 5×10^{-10} mbar at all times. Linearly polarized synchrotron radiation (spot-size 900 μ m horizontal, 100 μ m vertical) impinged on the film at an incidence angle of 20°, with an energy bandwidth of 350 meV. At grazing incidence, selecting p-polarized light puts the E-vector of the X-rays in the plane of the film stack, whereas selecting s-polarized light placed the E-vector close to the normal of the heterointerface film structure.

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